

# Schottky Barrier Diode RB751S40

These Schottky barrier diodes are designed for high-speed switching applications, circuit protection, and voltage clamping. Extremely low forward voltage reduces conduction loss. Miniature surface mount package is excellent for hand-held and portable applications where space is limited.

#### **Features**

- Extremely Fast Switching Speed
- Extremely Low Forward Voltage 0.28 V (Typ) @  $I_F = 1.0 \text{ mAdc}$
- Low Reverse Current
- Lead-Free Plating
- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

#### **MAXIMUM RATINGS**

Rating		Symbol	Value	Unit
Peak Reverse Voltage		$V_{RM}$	40	V
Reverse Voltage		V <sub>R</sub>	30	V
Forward Continuous Current (DC)		IF	30	mA
Peak Forward Surge Current		I <sub>FSM</sub>	500	mA
ESD Rating: Class 1C per Human Body Model Class A per Machine Model				

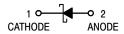
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board, (Note 1) T <sub>A</sub> = 25°C	P <sub>D</sub>	200	mW
Derate above 25°C		1.57	mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{ heta JA}$	635	°C/W
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

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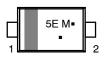
#### 40 V SCHOTTKY BARRIER DIODE





SOD-523 CASE 502 STYLE 1

#### MARKING DIAGRAM



5E = Specific Device Code

M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

#### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
RB751S40T1G	SOD-523 (Pb-Free)	3000 / Tape & Reel
NSVRB751S40T1G	SOD-523 (Pb-Free)	3000 / Tape & Reel
RB751S40T5G	SOD-523 (Pb-Free)	8000 / Tape & Reel
NSVRB751S40T5G	SOD-523 (Pb-Free)	8000 / Tape & Reel

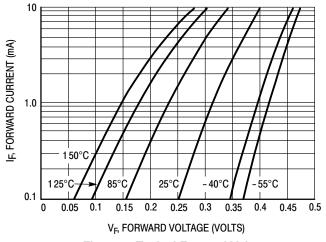
<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

<sup>1.</sup> FR-5 Minimum Pad.

#### **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Breakdown Voltage (I <sub>R</sub> = 10 μA)	V <sub>(BR)R</sub>	30	-	-	V
Total Capacitance (V <sub>R</sub> = 1.0 V, f = 1.0 MHz)	C <sub>T</sub>	-	2.0	2.5	pF
Reverse Leakage (V <sub>R</sub> = 30 V)	I <sub>R</sub>	-	300	500	nAdc
Forward Voltage (I <sub>F</sub> = 1.0 mAdc)	V <sub>F</sub>	-	0.28	0.37	Vdc

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



1000 T<sub>A</sub> = 150°C 100 I<sub>R</sub>, REVERSE CURRENT (μA) 125°C 10  $85^{\circ}C$ 1.0 0.1 25°C 0.01 0.001 0 15 25 30 35 V<sub>R</sub>, REVERSE VOLTAGE (VOLTS)

Figure 1. Typical Forward Voltage

Figure 2. Reverse Current versus Reverse Voltage

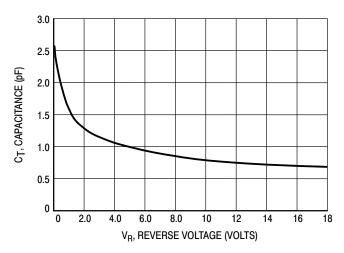


Figure 3. Typical Capacitance





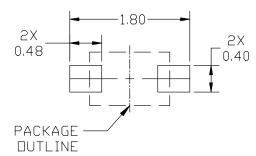
#### SOD-523 1.20x0.80x0.60 CASE 502 ISSUE F

**DATE 08 FEB 2024** 

#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH, MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

	MILLIMETERS			
DIM	MIN.	N□M.	MAX.	
А	0.50	0.60	0.70	
b	0.25	0.30	0.35	
C	0.07	0.14	0.20	
D	1.10	1.20	1.30	
E	0.70	0.80	0.90	
Н	1.50	1.60	1.70	
L	0.30 REF			
L2	0.15	0.20	0.25	

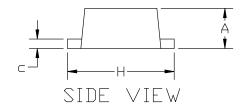


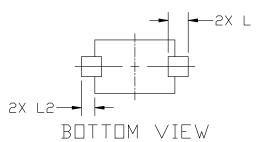
## RECOMMENDED MOUNTING FOOTPRINT

\*For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference manual SDLDERRM/D.

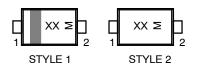
# 2X b 1 2 E







### GENERIC MARKING DIAGRAM\*



XX = Specific Device Code M Date Code

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

STYLE 1: S
PIN 1. CATHODE (POLARITY BAND)

STYLE 2: NO POLARITY

DOCUMENT NUMBER:

98AON11524D

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**DESCRIPTION:** 

SOD-523 1.20x0.80x0.60

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